

#10/A Gp #2826  
2/3/03  
Mullen



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: )  
AMMAR )  
Serial No. 09/863,030 ) Examiner: J. Mondt  
Filing Date: May 22, 2001 )  
Confirmation No. 7280 )  
For: THICK FILM MILLIMETER WAVE ) Art Unit: 2826  
TRANSCEIVER MODULE )  
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)

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TECHNOLOGY CENTER 2800

AMENDMENT

Director, U.S. Patent and Trademark Office  
Washington, DC 20231

Sir:

Responsive to the Official Action of October 24, 2002, please enter the amendments and remarks set out below.

In the Claims:

Please amend Claims 1, 10, 16 and 26 as follows:

A | 1. (ONCE AMENDED) A thick film millimeter wave transceiver module comprising:

base plate;

a multi-layer, thick film substrate board formed from a plurality of layers of low temperature co-fired ceramic material and received on said base plate and MMIC chips directly attached to the substrate board, said layers comprising at least one of